

PHASE CONTROL THYRISTOR

AT875

Repetitive voltage up to **4400 V**
Mean forward current **2003 A**
Surge current **25,2 kA**

FINAL SPECIFICATION

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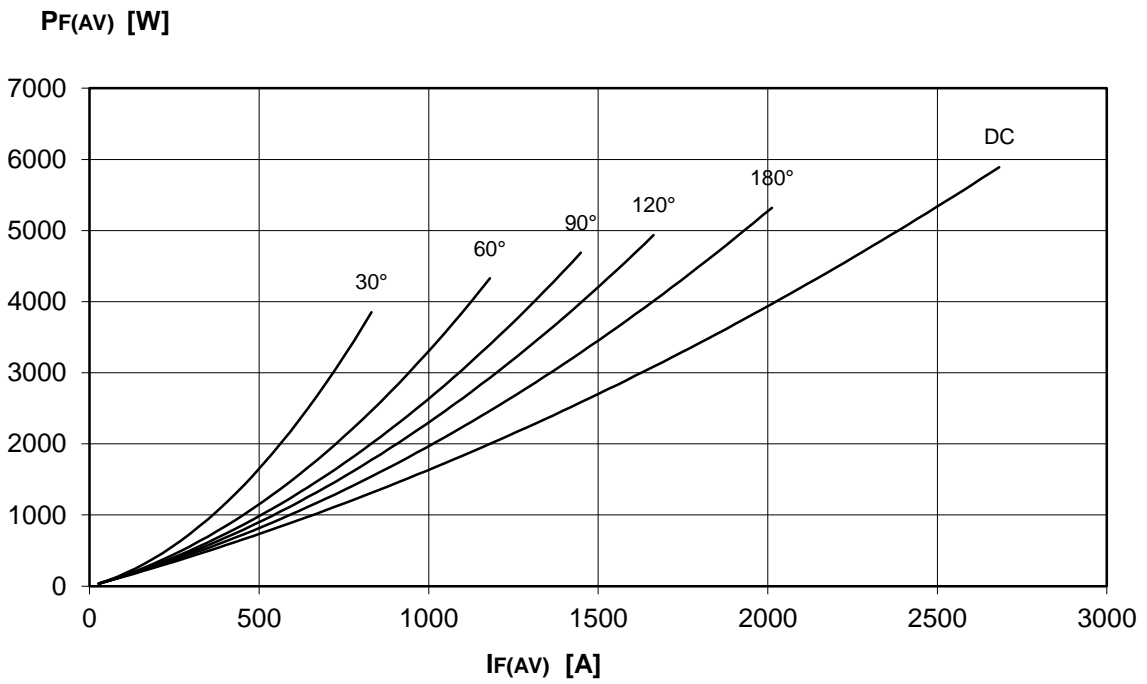
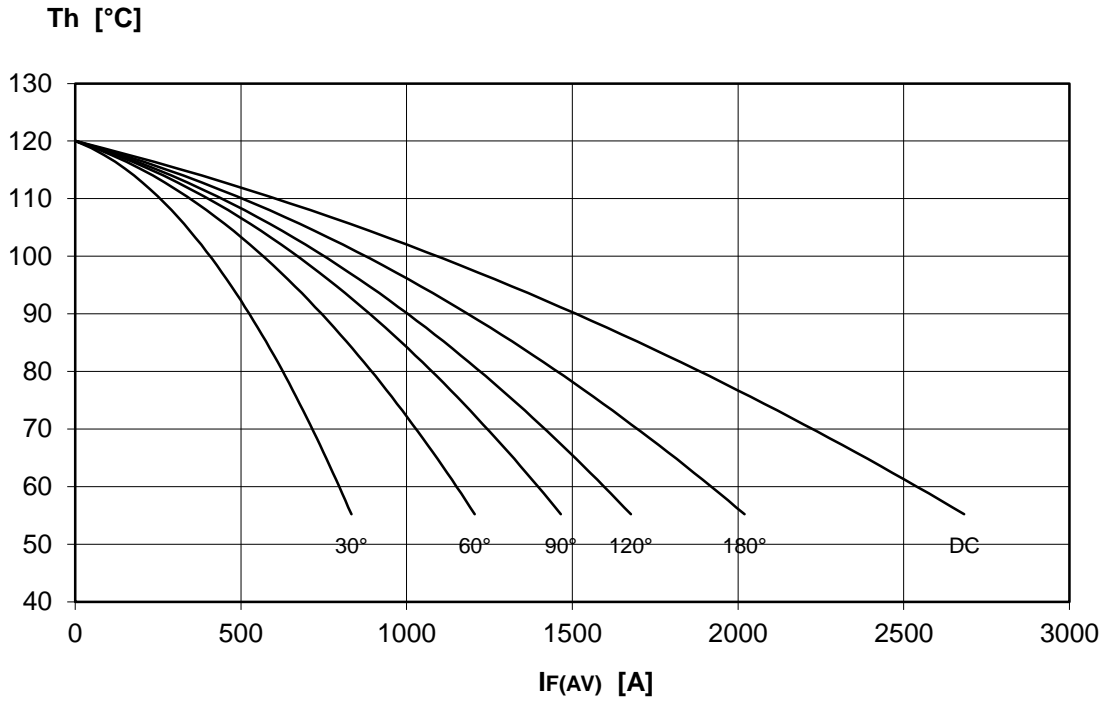
Symbol	Characteristic	Conditions	T _j [°C]	Value	Unit
BLOCKING					
V _{RRM}	Repetitive peak reverse voltage		120	4400	V
V _{RSM}	Non-repetitive peak reverse voltage		120	4500	V
V _{DRM}	Repetitive peak off-state voltage		120	4400	V
I _{RRM}	Repetitive peak reverse current	V=VRRM	120	200	mA
I _{DRM}	Repetitive peak off-state current	V=VDRM	120	200	mA
CONDUCTING					
I _{T(AV)}	Mean forward current	180° sin ,50 Hz, Th=55°C, double side cooled		2003	A
I _{T(AV)}	Mean forward current	180° sin ,50 Hz, Tc=85°C, double side cooled		1522	A
I _{TSM}	Surge forward current	Sine wave, 10 ms	120	25,2	kA
I ² t	I ² t	without reverse voltage		3175 x 10 ³	A ² s
V _T	On-state voltage	On-state current = 2000 A	25	2,00	V
V _{T(TO)}	Threshold voltage		120	1,30	V
r _T	On-state slope resistance		120	0,334	mohm
SWITCHING					
di/dt	Critical rate of rise of on-state current, min.	From 75% VDRM up to 1600 A; gate 10V, 5Ω	120	200	A/μs
dv/dt	Critical rate of rise of off-state voltage, min.	Linear ramp up to 70% of VDRM	120	1000	V/μs
t _d	Gate controlled delay time, typical	VD=100V; gate source 40V, 10Ω, tr=.5 μs	25	3	μs
t _q	Circuit commutated turn-off time, typical	dv/dt = 20 V/μs linear up to 75% VDRM		400	μs
Q _{rr}	Reverse recovery charge	di/dt = -20 A/μs, I= 1050 A	120		μC
I _{rr}	Peak reverse recovery current	VR= 50 V			A
I _H	Holding current, typical	VD=5V, gate open circuit	25	300	mA
I _L	Latching current, typical	VD=12V, tp=30μs	25	1000	mA
GATE					
V _{GT}	Gate trigger voltage	VD=12V	25	3,50	V
I _{GT}	Gate trigger current	VD=12V	25	400	mA
V _{GD}	Non-trigger gate voltage, min.	VD=VDRM	120	0,80	V
V _{FGM}	Peak gate voltage (forward)			30	V
I _{FGM}	Peak gate current			10	A
V _{RGM}	Peak gate voltage (reverse)			10	V
P _{GM}	Peak gate power dissipation	Pulse width 100 μs		150	W
P _G	Average gate power dissipation			2	W
MOUNTING					
R _{th(j-h)}	Thermal impedance, DC	Junction to heatsink, double side cooled		11	°C/kW
R _{th(c-h)}	Thermal impedance	Case to heatsink, double side cooled		2	°C/kW
T _j	Operating junction temperature			-30 / 120	°C
F	Mounting force			40.0 / 50.0	kN
	Mass			1700	g

ORDERING INFORMATION : AT875 S 44

standard specification VRRM/100

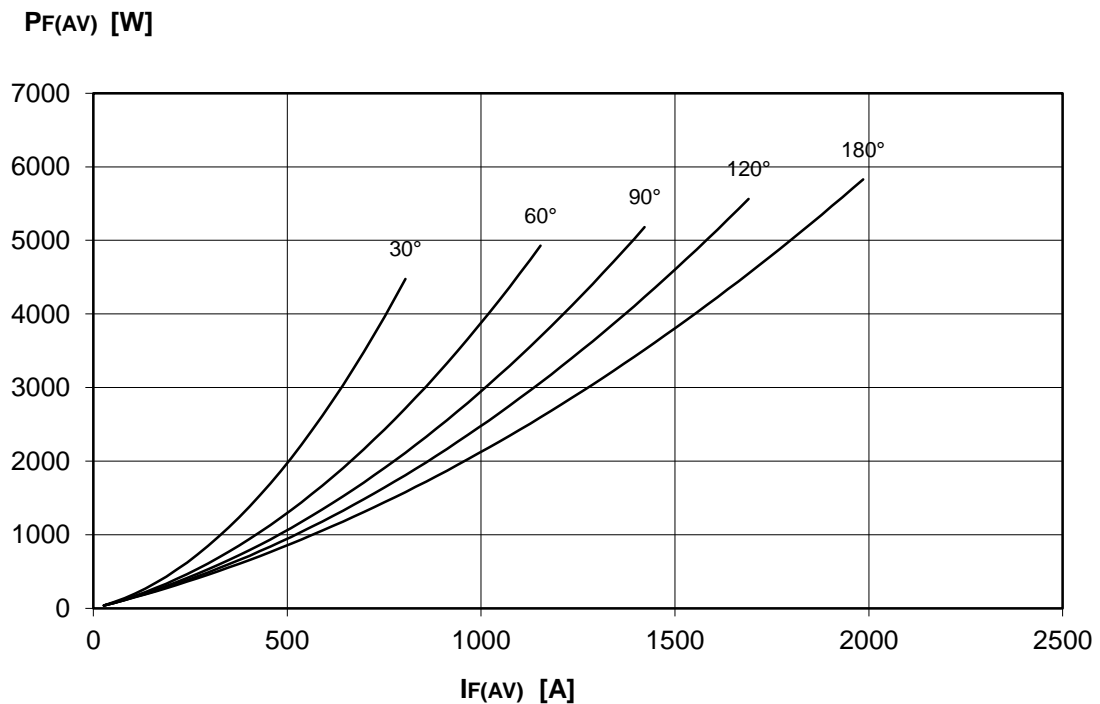
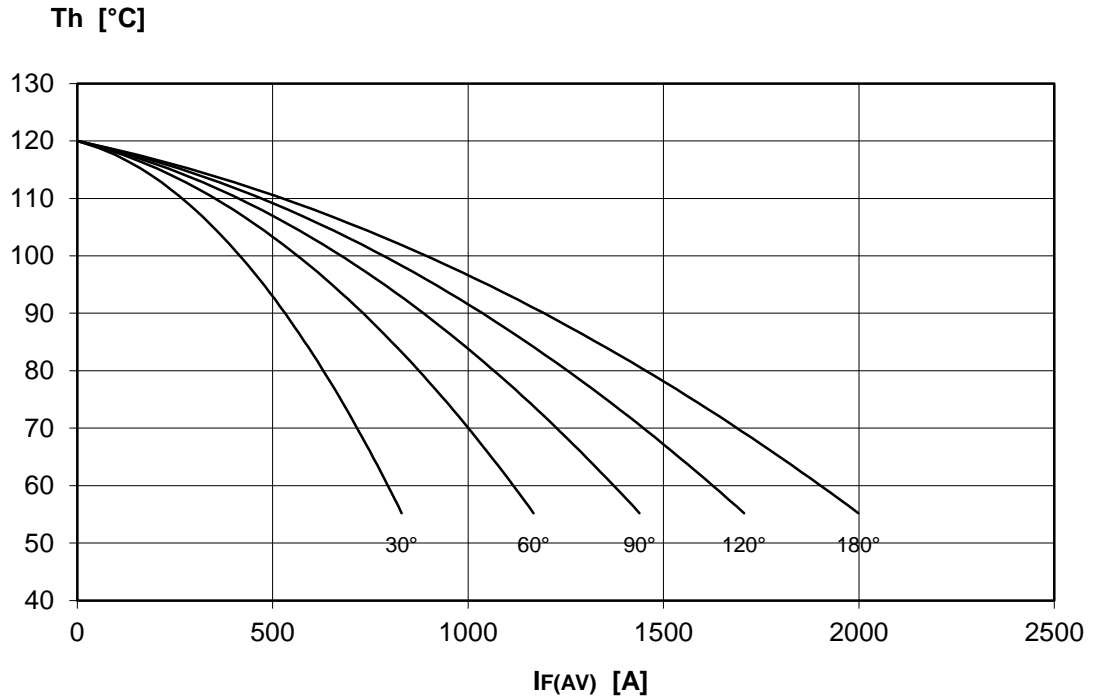
DISSIPATION CHARACTERISTICS

SQUARE WAVE



DISSIPATION CHARACTERISTICS

SINE WAVE

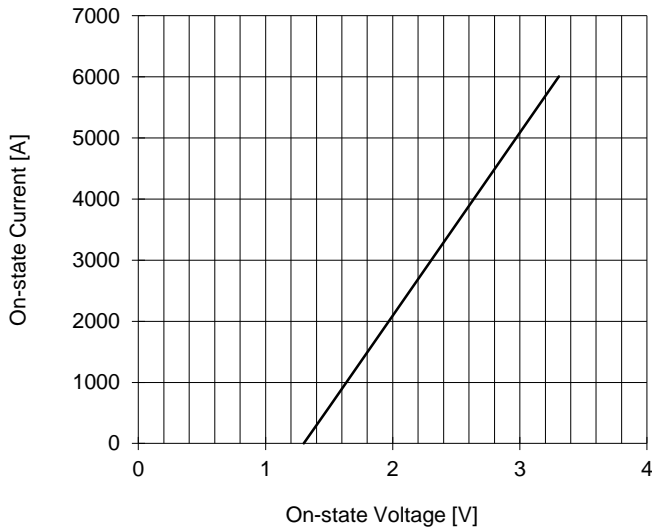


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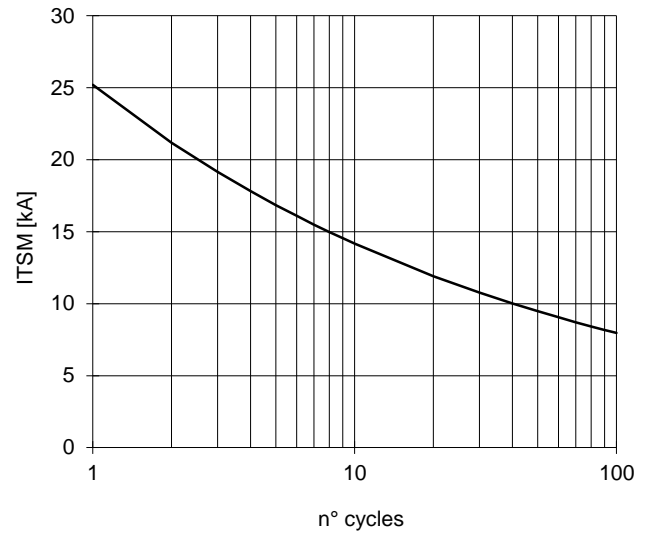


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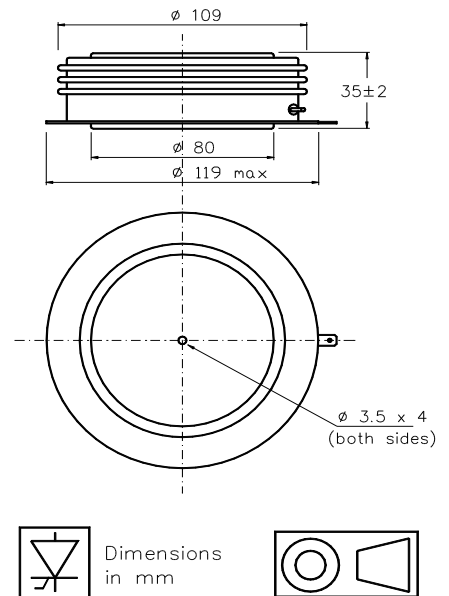
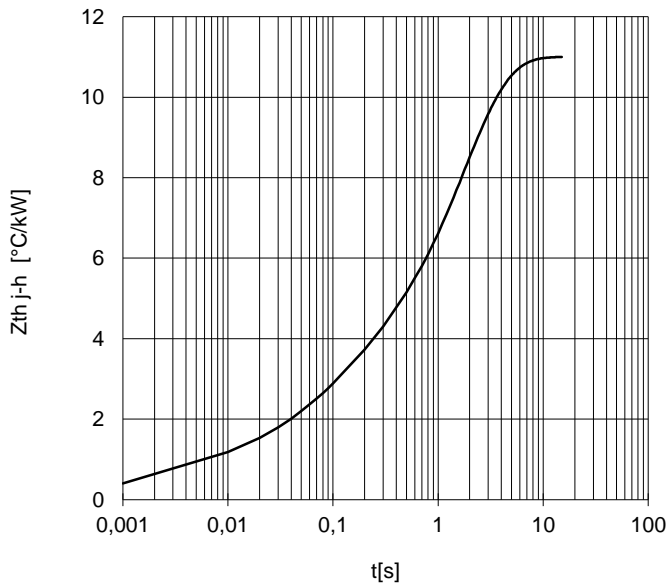
ON-STATE CHARACTERISTIC
T_j = 120 °C



SURGE CHARACTERISTIC
T_j = 120 °C



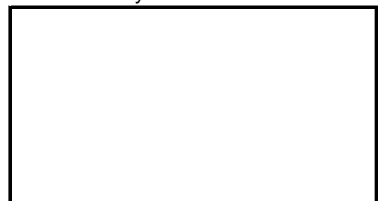
TRANSIENT THERMAL IMPEDANCE
DOUBLE SIDE COOLED



Cathode terminal type DIN 46244 - A 4.8 - 0.8

Gate terminal type AMP 60598 - 1

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All the characteristics given in this data sheet are guaranteed only with uniform clamping force, cleaned and lubricated heatsink, surfaces with flatness < .03 mm and roughness < 2 μm. In the interest of product improvement POSEICO SpA reserves the right to change any data given in this data sheet at any time without previous notice. If not stated otherwise the maximum value of ratings (symbols over shaded background) and characteristics is reported.